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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	17
Program Memory Size	8KB (2.75K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	20-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f08kl201-e-p

TABLE 4-4: ICN REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CNPD1	0056	CN15PDE(1)	CN14PDE(1)	CN13PDE(1)	CN12PDE	CN11PDE	—	CN9PDE(2)	CN8PDE	CN7PDE(2)	CN6PDE(1)	CN5PDE(1)	CN4PDE(1)	CN3PDE	CN2PDE	CN1PDE	CN0PDE	0000
CNPD2	0058	—	CN30PDE	CN29PDE	—	CN27PDE(2)	—	—	CN24PDE(2)	CN23PDE(1)	CN22PDE	CN21PDE	—	—	—	—	CN16PDE(2)	0000
CNEN1	0062	CN15IE(1)	CN14IE(1)	CN13IE(1)	CN12IE	CN11IE	—	CN9IE(1)	CN8IE	CN7IE(1)	CN6IE(2)	CN5PIE(2)	CN4IE(2)	CN3IE	CNIE	CN1IE	CN0IE	0000
CNEN2	0064	—	CN30IE	CN29IE	—	CN27IE(2)	—	—	CN24IE(2)	CN23IE(1)	CN22IE	CN21IE	—	—	—	—	CN16IE(2)	0000
CNPU1	006E	CN15PUE(1)	CN14PUE(1)	CN13PUE(1)	CN12PUE	CN11PUE	—	CN9PUE(1)	CN8PUE	CN7PUE(1)	CN6PUE(2)	CN5PUE(2)	CN4PUE(2)	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000
CNPU2	0070	—	CN30PUE	CN29PUE	—	CN27PUE(2)	—	—	CN24PUE(2)	CN23PUE(1)	CN22PUE	CN21PUE	—	—	—	—	CN16PUE(2)	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

2: These bits are unimplemented in 14-pin and 20-pin devices; read as '0'.

TABLE 4-6: TIMER REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TMR1	0100	Timer1 Register																0000
PR1	0102	Timer1 Period Register																FFFF
T1CON	0104	TON	—	TSIDL	—	—	—	T1ECS1	T1ECS0	—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—	0000
TMR2	0106	—	—	—	—	—	—	—	—	Timer2 Register								0000
PR2	0108	—	—	—	—	—	—	—	—	Timer2 Period Register								00FF
T2CON	010A	—	—	—	—	—	—	—	—	—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	0000
TMR3	010C	Timer3 Register																0000
T3GCON	010E	—	—	—	—	—	—	—	—	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/$\overline{\text{T3DONE}}$	T3GVAL	T3GSS1	T3GSS0	0000
T3CON	0110	—	—	—	—	—	—	—	—	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	T3OSCEN	$\overline{\text{T3SYNC}}$	—	TMR3ON	0000
TMR4(1)	0112	—	—	—	—	—	—	—	—	Timer4 Register								0000
PR4(1)	0114	—	—	—	—	—	—	—	—	Timer4 Period Register								00FF
T4CON(1)	0116	—	—	—	—	—	—	—	—	—	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	0000
CCPTMRS0(1)	013C	—	—	—	—	—	—	—	—	—	C3TSEL0(1)	—	—	C2TSEL0	—	—	C1TSEL0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-7: CCP/ECCP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CCP1CON	0190	—	—	—	—	—	—	—	—	PM1(1)	PM0(1)	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000
CCPR1L	0192	—	—	—	—	—	—	—	—	Capture/Compare/PWM1 Register Low Byte								0000
CCPR1H	0194	—	—	—	—	—	—	—	—	Capture/Compare/PWM1 Register High Byte								0000
ECCP1DEL(1)	0196	—	—	—	—	—	—	—	—	PRSEN	PDC6	PDC5	PDC4	PDC3	PDC2	PDC1	PDC0	0000
ECCP1AS(1)	0198	—	—	—	—	—	—	—	—	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0	0000
PSTR1CON(1)	019A	—	—	—	—	—	—	—	—	CMPL1	CMPL0	—	STRSYNC	STRD	STRC	STRB	STRA	0001
CCP2CON	019C	—	—	—	—	—	—	—	—	—	—	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	0000
CCPR2L	019E	—	—	—	—	—	—	—	—	Capture/Compare/PWM2 Register Low Byte								0000
CCPR2H	01A0	—	—	—	—	—	—	—	—	Capture/Compare/PWM2 Register High Byte								0000
CCP3CON(1)	01A8	—	—	—	—	—	—	—	—	—	—	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	0000
CCPR3L(1)	01AA	—	—	—	—	—	—	—	—	Capture/Compare/PWM3 Register Low Byte								0000
CCPR3H(1)	01AC	—	—	—	—	—	—	—	—	Capture/Compare/PWM3 Register High Byte								0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-16: SYSTEM REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0740	TRAPR	IOPUWR	SBOREN	—	—	—	CM	PMSLP	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	(Note 1)
OSCCON	0742	—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0	CLKLOCK	—	LOCK	—	CF	SOSCDRV	SOSCEN	OSWEN	(Note 2)
CLKDIV	0744	ROI	DOZE2	DOZE1	DOZE0	DOZEN	RCDIV2	RCDIV1	RCDIV0	—	—	—	—	—	—	—	—	3100
OSCTUN	0748	—	—	—	—	—	—	—	—	—	—	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000
REFOCON	074E	ROEN	—	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0	—	—	—	—	—	—	—	—	0000
HLVDCON	0756	HLVDEN	—	HLSIDL	—	—	—	—	—	VDIR	BGVST	IRVST	—	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: RCON register Reset values are dependent on the type of Reset.

2: OSCCON register Reset values are dependent on configuration fuses and by type of Reset.

TABLE 4-17: NVM REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
NVMCON	0760	WR	WREN	WRERR	PGMONLY	—	—	—	—	—	ERASE	NVMOP5	NVMOP4	NVMOP3	NVMOP2	NVMOP1	NVMOP0	0000
NVMKEY	0766	—	—	—	—	—	—	—	—	NVM Key Register								0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-18: ULTRA LOW-POWER WAKE-UP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ULPWCON	0768	ULPEN	—	ULPSIDL	—	—	—	—	ULPSINK	—	—	—	—	—	—	—	—	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-19: PMD REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0770	—	T4MD	T3MD	T2MD	T1MD	—	—	—	SSP1MD	U2MD	U1MD	—	—	—	—	ADC1MD	0000
PMD2	0772	—	—	—	—	—	—	—	—	—	—	—	—	—	CCP3MD	CCP2MD	CCP1MD	0000
PMD3	0774	—	—	—	—	—	CMPMD	—	—	—	—	—	—	—	—	SSP2MD	—	0000
PMD4	0776	—	—	—	—	—	—	—	—	ULPWUMD	—	—	EEMD	REFOMD	—	HLVDMD	—	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

5.2 RTSP Operation

The PIC24F Flash program memory array is organized into rows of 32 instructions or 96 bytes. RTSP allows the user to erase blocks of 1 row, 2 rows and 4 rows (32, 64 and 128 instructions) at a time, and to program one row at a time.

The 1-row (96 bytes), 2-row (192 bytes) and 4-row (384 bytes) erase blocks and single row write block (96 bytes) are edge-aligned, from the beginning of program memory.

When data is written to program memory using TBLWT instructions, the data is not written directly to memory. Instead, data written using Table Writes is stored in holding latches until the programming sequence is executed.

Any number of TBLWT instructions can be executed and a write will be successfully performed. However, 32 TBLWT instructions are required to write the full row of memory.

The basic sequence for RTSP programming is to set up a Table Pointer, then do a series of TBLWT instructions to load the buffers. Programming is performed by setting the control bits in the NVMCON register.

Data can be loaded in any order and the holding registers can be written to multiple times before performing a write operation. Subsequent writes, however, will wipe out any previous writes.

Note:	Writing to a location multiple times without erasing it is not recommended.

All of the Table Write operations are single-word writes (two instruction cycles), because only the buffers are written. A programming cycle is required for programming each row.

5.3 Enhanced In-Circuit Serial Programming

Enhanced ICSP uses an on-board bootloader, known as the program executive, to manage the programming process. Using an SPI data frame format, the program executive can erase, program and verify program memory. For more information on Enhanced ICSP, see the device programming specification.

5.4 Control Registers

There are two SFRs used to read and write the program Flash memory: NVMCON and NVMKEY.

The NVMCON register (Register 5-1) controls the blocks that need to be erased, which memory type is to be programmed and when the programming cycle starts.

NVMKEY is a write-only register that is used for write protection. To start a programming or erase sequence, the user must consecutively write 55h and AAh to the NVMKEY register. For more information, refer to **Section 5.5 “Programming Operations”**.

5.5 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. During a programming or erase operation, the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

REGISTER 8-11: IEC0: INTERRUPT ENABLE CONTROL REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
NVMIE	—	AD1IE	U1TXIE	U1RXIE	—	—	T3IE
bit 15							bit 8

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0
T2IE	CCP2IE	—	—	T1IE	CCP1IE	—	INT0IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **NVMIE:** NVM Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 14 **Unimplemented:** Read as '0'

bit 13 **AD1IE:** A/D Conversion Complete Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 12 **U1TXIE:** UART1 Transmitter Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 11 **U1RXIE:** UART1 Receiver Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 10-9 **Unimplemented:** Read as '0'

bit 8 **T3IE:** Timer3 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 7 **T2IE:** Timer2 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 6 **CCP2IE:** Capture/Compare/PWM2 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 5-4 **Unimplemented:** Read as '0'

bit 3 **T1IE:** Timer1 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 2 **CCP1IE:** Capture/Compare/PWM1 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 1 **Unimplemented:** Read as '0'

bit 0 **INT0IE:** External Interrupt 0 Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

REGISTER 8-30: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER

R-0	r-0	R/W-0	U-0	R-0	R-0	R-0	R-0
CPUIRQ	r	VHOLD	—	ILR3	ILR2	ILR1	ILR0
bit 15							bit 8

U-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
—	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0
bit 7							bit 0

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CPUIRQ:** Interrupt Request from Interrupt Controller CPU bit
1 = An interrupt request has occurred but has not yet been Acknowledged by the CPU (this will happen when the CPU priority is higher than the interrupt priority)
0 = No interrupt request is left unacknowledged

bit 14 **Reserved:** Maintain as '0'

bit 13 **VHOLD:** Vector Hold bit
Allows Vector Number Capture and Changes What Interrupt is Stored in the VECNUM bit:
1 = VECNUM<6:0> will contain the value of the highest priority pending interrupt, instead of the current interrupt
0 = VECNUM<6:0> will contain the value of the last Acknowledged interrupt (last interrupt that has occurred with higher priority than the CPU, even if other interrupts are pending)

bit 12 **Unimplemented:** Read as '0'

bit 11-8 **ILR<3:0>:** New CPU Interrupt Priority Level bits
1111 = CPU Interrupt Priority Level is 15
•
•
•
0001 = CPU Interrupt Priority Level is 1
0000 = CPU Interrupt Priority Level is 0

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **VECNUM<6:0>:** Vector Number of Pending Interrupt bits
0111111 = Interrupt vector pending is Number 135
•
•
•
0000001 = Interrupt vector pending is Number 9
0000000 = Interrupt vector pending is Number 8

9.3 Control Registers

The operation of the oscillator is controlled by three Special Function Registers (SFRs):

- OSCCON
- CLKDIV
- OSCTUN

The OSCCON register (Register 9-1) is the main control register for the oscillator. It controls clock source switching and allows the monitoring of clock sources.

The Clock Divider register (Register 9-2) controls the features associated with Doze mode, as well as the postscaler for the FRC oscillator.

The FRC Oscillator Tune register (Register 9-3) allows the user to fine-tune the FRC oscillator. OSCTUN functionality has been provided to help customers compensate for temperature effects on the FRC frequency over a wide range of temperatures. The tuning step-size is an approximation and is neither characterized nor tested.

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R-0, HSC	R-0, HSC	R-0, HSC	U-0	R/W-x(1)	R/W-x(1)	R/W-x(1)
—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0
bit 15							bit 8

R/SO-0, HSC	U-0	R-0, HSC(2)	U-0	R/CO-0, HS	R/W-0(3)	R/W-0	R/W-0
CLKLOCK	—	LOCK	—	CF	SOSCDRV	SOSCEN	OSWEN
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
HS = Hardware Settable bit	CO = Clearable Only bit	SO = Settable Only bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **COSC<2:0>:** Current Oscillator Selection bits
111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)
110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)
101 = Low-Power RC Oscillator (LPRC)
100 = Secondary Oscillator (SOSC)
011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)
010 = Primary Oscillator (XT, HS, EC)
001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)
000 = 8 MHz FRC Oscillator (FRC)

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **NOSC<2:0>:** New Oscillator Selection bits(1)
111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)
110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)
101 = Low-Power RC Oscillator (LPRC)
100 = Secondary Oscillator (SOSC)
011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)
010 = Primary Oscillator (XT, HS, EC)
001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)
000 = 8 MHz FRC Oscillator (FRC)

Note 1: Reset values for these bits are determined by the FNOSC<2:0> Configuration bits.
2: Also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.
3: When SOSC is selected to run from a digital clock input rather than an external crystal (SOSCSRC = 0), this bit has no effect.

REGISTER 10-1: ULPWCON: ULPWU CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0
ULPEN	—	ULPSIDL	—	—	—	—	ULPSINK
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **ULPEN:** ULPWU Module Enable bit
1 = Module is enabled
0 = Module is disabled

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **ULPSIDL:** ULPWU Stop in Idle Select bit
1 = Discontinues module operation when the device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-9 **Unimplemented:** Read as ‘0’

bit 8 **ULPSINK:** ULPWU Current Sink Enable bit
1 = Current sink is enabled
0 = Current sink is disabled

bit 7-0 **Unimplemented:** Read as ‘0’

11.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx and TRISx registers for data control, each port pin can be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The maximum open-drain voltage allowed is the same as the maximum V_{IH} specification.

11.1.2 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically, this instruction would be a NOP.

11.2 Configuring Analog Port Pins

The use of the ANSx and TRISx registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRISx bit set (input). If the TRISx bit is cleared (output), the digital output level (V_{OH} or V_{OL}) will be converted.

When reading the PORTx register, all pins configured as analog input channels will read as cleared (a low level). Analog levels on any pin that is defined as a digital input (including the ANx pins) may cause the input buffer to consume current that exceeds the device specifications.

11.2.1 ANALOG SELECTION REGISTER

I/O pins with shared analog functionality, such as A/D inputs and comparator inputs, must have their digital inputs shut off when analog functionality is used. Note that analog functionality includes an analog voltage being applied to the pin externally.

To allow for analog control, the ANSx registers are provided. There is one ANS register for each port (ANSA and ANSB, Register 11-1 and Register 11-2). Within each ANSx register, there is a bit for each pin that shares analog functionality with the digital I/O functionality. If a particular pin does not have an analog function, that bit is unimplemented.

REGISTER 16-2: CCP1CON: ECCP1 CONTROL REGISTER (ECCP MODULES ONLY)(1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PM1	PM0	DC1B1	DC1B0	CCP1M3(2)	CCP1M2(2)	CCP1M1(2)	CCP1M0(2)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-6 **PM<1:0>:** Enhanced PWM Output Configuration bits

If CCP1M<3:2> = 00, 01, 10:

xx = P1A is assigned as a capture input or compare output; P1B, P1C and P1D are assigned as port pins

If CCP1M<3:2> = 11:

11 = Full-bridge output reverse: P1B is modulated; P1C is active; P1A and P1D are inactive

10 = Half-bridge output: P1A, P1B are modulated with dead-band control; P1C and P1D are assigned as port pins

01 = Full-bridge output forward: P1D is modulated; P1A is active; P1B, P1C are inactive

00 = Single output: P1A, P1B, P1C and P1D are controlled by steering

bit 5-4 **DC1B<1:0>**: PWM Duty Cycle bit 1 and bit 0 for CCP1 Module bits

Capture and Compare modes:

Unused.

PWM mode:

These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DC1B<9:2>) of the duty cycle are found in CCPR1L.

bit 3-0 **CCP1M<3:0>**: ECCP1 Module Mode Select bits(2)

1111 = PWM mode: P1A and P1C are active-low; P1B and P1D are active-low

1110 = PWM mode: P1A and P1C are active-low; P1B and P1D are active-high

1101 = PWM mode: P1A and P1C are active-high; P1B and P1D are active-low

1100 = PWM mode: P1A and P1C are active-high; P1B and P1D are active-high

1011 = Compare mode: Special Event Trigger; resets timer on CCP1 match (CCPxIF bit is set)

1010 = Compare mode: Generates software interrupt on compare match (CCP1IF bit is set, CCP1 pin reflects I/O state)

1001 = Compare mode: Initializes CCP1 pin high; on compare match, forces CCP1 pin low (CCP1IF bit is set)

1000 = Compare mode: Initializes CCP1 pin low; on compare match, forces CCP1 pin high (CCP1IF bit is set)

0111 = Capture mode: Every 16th rising edge

0110 = Capture mode: Every 4th rising edge

0101 = Capture mode: Every rising edge

0100 = Capture mode: Every falling edge

0011 = Reserved

0010 = Compare mode: Toggles output on match (CCP1IF bit is set)

0001 = Reserved

0000 = Capture/Compare/PWM is disabled (resets CCP1 module)

Note 1: This register is implemented only on PIC24FXXKL40X/30X devices. For all other devices, CCP1CON is configured as Register 16-1.

2: CCP1M<3:0> = 1011 will only reset the timer and not start the A/D conversion on a CCP1 match.

REGISTER 16-6: CCPTMRS0: CCP TIMER SELECT CONTROL REGISTER 0(1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	U-0	U-0	R/W-0	U-0	U-0	R/W-0
—	C3TSEL0	—	—	C2TSEL0	—	—	C1TSEL0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6 **C3TSEL0:** CCP3 Timer Selection bit
1 = CCP3 uses TMR3/TMR4
0 = CCP3 uses TMR3/TMR2

bit 5-4 **Unimplemented:** Read as ‘0’

bit 3 **C2TSEL0:** CCP2 Timer Selection bit
1 = CCP2 uses TMR3/TMR4
0 = CCP2 uses TMR3/TMR2

bit 2-1 **Unimplemented:** Read as ‘0’

bit 0 **C1TSEL0:** CCP1/ECCP1 Timer Selection bit
1 = CCP1/ECCP1 uses TMR3/TMR4
0 = CCP1/ECCP1 uses TMR3/TMR2

Note 1: This register is unimplemented on PIC24FXXKL20X/10X devices; maintain as ‘0’.

REGISTER 18-1: UxMODE: UARTx MODE REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0(2)	R/W-0(2)
UARTEN	—	USIDL	IREN(1)	RTSMD	—	UEN1	UEN0
bit 15							bit 8

R/C-0, HC	R/W-0	R/W-0, HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL
bit 7							bit 0

Legend:	C = Clearable bit	HC = Hardware Clearable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **UARTEN:** UARTx Enable bit
- 1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by UEN<1:0>
- 0 = UARTx is disabled; all UARTx pins are controlled by port latches, UARTx power consumption is minimal

bit 14 **Unimplemented:** Read as '0'

bit 13 **USIDL:** UARTx Stop in Idle Mode bit
- 1 = Discontinues module operation when device enters Idle mode
- 0 = Continues module operation in Idle mode

bit 12 **IREN:** IrDA® Encoder and Decoder Enable bit(1)
- 1 = IrDA encoder and decoder are enabled
- 0 = IrDA encoder and decoder are disabled

bit 11 **RTSMD:** Mode Selection for $\overline{\text{UxRTS}}$ Pin bit
- 1 = $\overline{\text{UxRTS}}$ pin is in Simplex mode
- 0 = $\overline{\text{UxRTS}}$ pin is in Flow Control mode

bit 10 **Unimplemented:** Read as '0'

bit 9-8 **UEN<1:0>:** UARTx Enable bits(2)
- 11 = UxTX, UxRX and UxBCLK pins are enabled and used; $\overline{\text{UxCTS}}$ pin is controlled by port latches
- 10 = UxTX, UxRX, $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins are enabled and used
- 01 = UxTX, UxRX and $\overline{\text{UxRTS}}$ pins are enabled and used; $\overline{\text{UxCTS}}$ pin is controlled by port latches
- 00 = UxTX and UxRX pins are enabled and used; $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$/UxBCLK pins are controlled by port latches

bit 7 **WAKE:** Wake-up on Start Bit Detect During Sleep Mode Enable bit
- 1 = UARTx will continue to sample the UxRX pin; interrupt is generated on the falling edge, bit is cleared in hardware on the following rising edge
- 0 = No wake-up is enabled

bit 6 **LPBACK:** UARTx Loopback Mode Select bit
- 1 = Enables Loopback mode
- 0 = Loopback mode is disabled

bit 5 **ABAUD:** Auto-Baud Enable bit
- 1 = Enables baud rate measurement on the next character – requires reception of a Sync field (55h); cleared in hardware upon completion
- 0 = Baud rate measurement is disabled or completed

bit 4 **RXINV:** Receive Polarity Inversion bit
- 1 = UxRX Idle state is '0'
- 0 = UxRX Idle state is '1'

Note 1: This feature is is only available for the 16x BRG mode (BRGH = 0).
2: Bit availability depends on pin availability.

19.0 10-BIT HIGH-SPEED A/D CONVERTER

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the 10-Bit High-Speed A/D Converter, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"10-Bit A/D Converter"** (DS39705).

The 10-bit A/D Converter has the following key features:

- Successive Approximation (SAR) conversion
- Conversion speeds of up to 500 ksps
- Up to 12 analog input pins
- External voltage reference input pins
- Internal band gap reference input
- Automatic Channel Scan mode
- Selectable conversion trigger source
- Two-word conversion result buffer
- Selectable Buffer Fill modes
- Four result alignment options
- Operation during CPU Sleep and Idle modes

Depending on the particular device, PIC24F16KL402 family devices implement up to 12 analog input pins, designated AN0 through AN4 and AN9 through AN15. In addition, there are two analog input pins for external voltage reference connections (V_{REF}+ and V_{REF}-). These voltage reference inputs may be shared with other analog input pins.

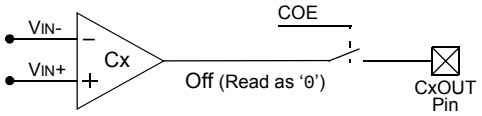
A block diagram of the A/D Converter is displayed in Figure 19-1.

To perform an A/D conversion:

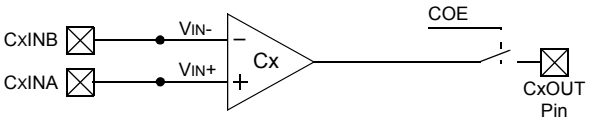
1. Configure the A/D module:
   a) Configure port pins as analog inputs and/or select band gap reference inputs (ANSA<3:0>, ANSB<15:12,4:0> and ANCFG<0>).
   b) Select the voltage reference source to match the expected range on analog inputs (AD1CON2<15:13>).
   c) Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
   d) Select the appropriate sample/conversion sequence (AD1CON1<7:5> and AD1CON3<12:8>).
   e) Select how conversion results are presented in the buffer (AD1CON1<9:8>).
   f) Select interrupt rate (AD1CON2<5:2>).
   g) Turn on A/D module (AD1CON1<15>).
2. Configure A/D interrupt (if required):
   a) Clear the AD1IF bit.
   b) Select A/D interrupt priority.

FIGURE 20-2: INDIVIDUAL COMPARATOR CONFIGURATIONS

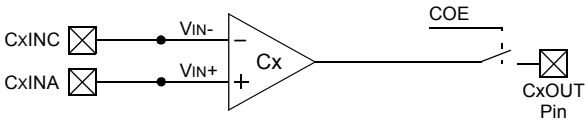
Comparator Off
CON = 0, CREF = x, CCH<1:0> = xx



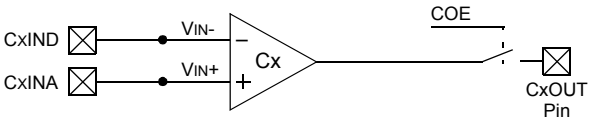
Comparator CxINB > CxINA Compare
CON = 1, CREF = 0, CCH<1:0> = 00



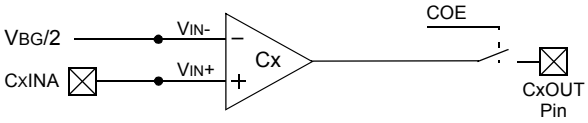
Comparator CxINC > CxINA Compare(1)
CON = 1, CREF = 0, CCH<1:0> = 01



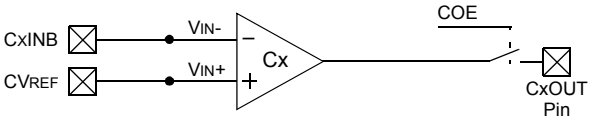
Comparator CxIND > CxINA Compare(1)
CON = 1, CREF = 0, CCH<1:0> = 10



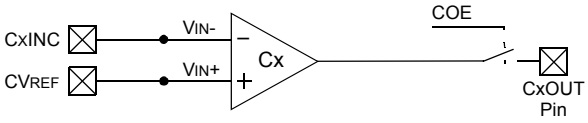
Comparator VBG > CxINA Compare
CON = 1, CREF = 0, CCH<1:0> = 11



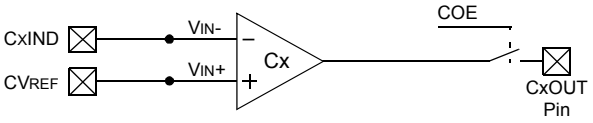
Comparator CxINB > CVREF Compare
CON = 1, CREF = 1, CCH<1:0> = 00



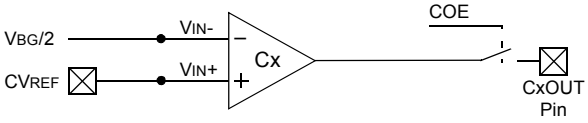
Comparator CxINC > CVREF Compare(1)
CON = 1, CREF = 1, CCH<1:0> = 01



Comparator CxIND > CVREF Compare(1)
CON = 1, CREF = 1, CCH<1:0> = 10



Comparator VBG > CVREF Compare
CON = 1, CREF = 1, CCH<1:0> = 11



Note 1: This configuration is unavailable on 14-pin (PIC24FXXKL100/200) devices.

REGISTER 20-1: CMxCON: COMPARATOR x CONTROL REGISTER (CONTINUED)

bit 3-2 **Unimplemented:** Read as '0'

bit 1-0 **CCH<1:0>:** Comparator Channel Select bits
11 = Inverting input of the comparator connects to V_{BG}/2
10 = Inverting input of the comparator connects to the CxIND pin(2)
01 = Inverting input of the comparator connects to the CxINC pin(2)
00 = Inverting input of the comparator connects to the CxINB pin

Note 1: If EVPOL<1:0> is set to a value other than '00', the first interrupt generated will occur on any transition of COUT, regardless of if it is a rising or falling edge. Subsequent interrupts will occur based on the EVPOLx bits setting.

2: Unimplemented on 14-pin (PIC24FXXKL100/200) devices.

REGISTER 20-2: CMSTAT: COMPARATOR MODULE STATUS REGISTER

R/W-0	U-0	U-0	U-0	U-0	U-0	R-0, HSC	R-0, HSC
CMIDL	—	—	—	—	—	C2EVT(1)	C1EVT
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	R-0, HSC	R-0, HSC
—	—	—	—	—	—	C2OUT(1)	C1OUT
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CMIDL:** Comparator Stop in Idle Mode bit
1 = Discontinues operation of all comparators when device enters Idle mode
0 = Continues operation of all enabled comparators in Idle mode

bit 14-10 **Unimplemented:** Read as '0'

bit 9 **C2EVT:** Comparator 2 Event Status bit (read-only)(1)
Shows the current event status of Comparator 2 (CM2CON<9>).

bit 8 **C1EVT:** Comparator 1 Event Status bit (read-only)
Shows the current event status of Comparator 1 (CM1CON<9>).

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **C2OUT:** Comparator 2 Output Status bit (read-only)(1)
Shows the current output of Comparator 2 (CM2CON<8>).

bit 0 **C1OUT:** Comparator 1 Output Status bit (read-only)
Shows the current output of Comparator 1 (CM1CON<8>).

Note 1: These bits are unimplemented on PIC24FXXKL10X/20X devices.

TABLE 26-6: DC CHARACTERISTICS: OPERATING CURRENT (I_{DD})(2)

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
IDD Current						
DC20	0.154	0.350	mA	1.8V	+85V°C	0.5 MIPS, FOSC = 1 MHz
	0.301	0.630		3.3V		
	—	.500	mA	1.8V	+125°C	
	—	.800		3.3V		
DC22	0.300	—	mA	1.8V	+85°C	1 MIPS, FOSC = 2 MHz
	0.585	—		3.3V		
DC24	7.76	12.0	mA	3.3V	+85°C	16 MIPS, FOSC = 32 MHz
	—	18.0		3.3V	+125°C	
DC26	1.44	—	mA	1.8V	+85°C	FRC (4 MIPS), FOSC = 8 MHz
	2.71	—		3.3V		
DC30	4.00	28.0	µA	1.8V	+85°C	LPRC (15.5 KIPS), FOSC = 31 kHz
	9.00	55.0		3.3V		
	—	45.0	µA	1.8V	+125°C	
	—	90.0		3.3V		

Note 1: Data in the Typical column is at 3.3V, +25°C, unless otherwise stated.

2: IDD is measured with all peripherals disabled. All I/Os are configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled.

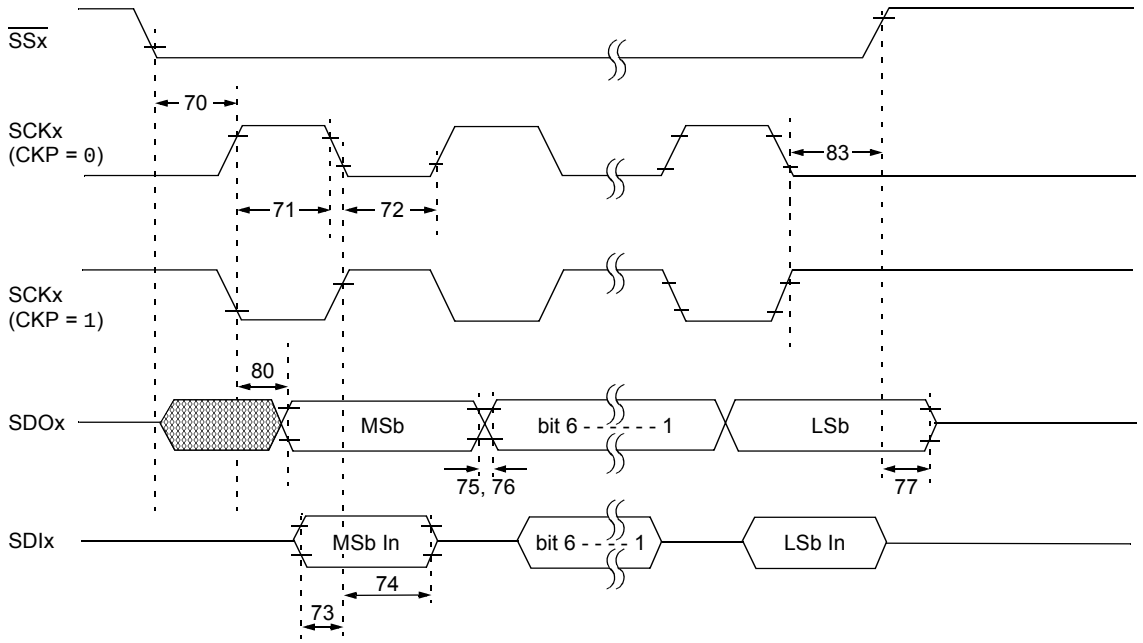
TABLE 26-7: DC CHARACTERISTICS: IDLE CURRENT (I_{IDLE})(2)

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
Idle Current (IIDLE)						
DC40	0.035	0.080	mA	1.8V	+85°C	0.5 MIPS, FOSC = 1 MHz
	0.077	0.150		3.3V		
	—	0.160	mA	1.8V	+125°C	
	—	0.300		3.3V		
DC42	0.076	—	mA	1.8V	+85°C	1 MIPS, FOSC = 2 MHz
	0.146	—		3.3V		
DC44	2.52	3.20	mA	3.3V	+85°C	16 MIPS, FOSC = 32 MHz
	—	5.00	mA	3.3V	+125°C	
DC46	0.45	—	mA	1.8V	+85°C	FRC (4 MIPS), FOSC = 8 MHz
	0.76	—	mA	3.3V		
DC50	0.87	18.0	µA	1.8V	+85°C	LPRC (15.5 KIPS), FOSC = 31 kHz
	1.55	40.0	µA	3.3V		
	—	27.0	µA	1.8V	+125°C	
	—	50.0	µA	3.3V		

Note 1: Data in the Typical column is at 3.3V, +25°C, unless otherwise stated.

2: IIDLE is measured with all I/Os configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled.

FIGURE 26-9: EXAMPLE SPI SLAVE MODE TIMING (CKE = 0)



Note: Refer to Figure 26-3 for load conditions.

TABLE 26-29: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{SSx}$ ↓ to SCKx ↓ or SCKx ↑ Input		3 Tcy	—	ns	
70A	TssL2WB	$\overline{SSx}$ to Write to SSPxBUF		3 Tcy	—	ns	
71	TscH	SCKx Input High Time (Slave mode)	Continuous	1.25 Tcy + 30	—	ns	
71A			Single Byte	40	—	ns	**(Note 1)**
72	TscL	SCKx Input Low Time (Slave mode)	Continuous	1.25 Tcy + 30	—	ns	
72A			Single Byte	40	—	ns	**(Note 1)**
73	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge		20	—	ns	
73A	Tb2b	Last Clock Edge of Byte 1 to the First Clock Edge of Byte 2		1.5 Tcy + 40	—	ns	**(Note 2)**
74	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge		40	—	ns	
75	TdoR	SDOx Data Output Rise Time		—	25	ns	
76	TdoF	SDOx Data Output Fall Time		—	25	ns	
77	TssH2doZ	$\overline{SSx}$ ↑ to SDOx Output High-Impedance		10	50	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge		—	50	ns	
83	TscH2ssH, TscL2ssH	$\overline{SSx}$ ↑ after SCKx Edge		1.5 Tcy + 40	—	ns	
	Fsck	SCKx Frequency		—	10	MHz	

Note 1: Requires the use of Parameter 73A.

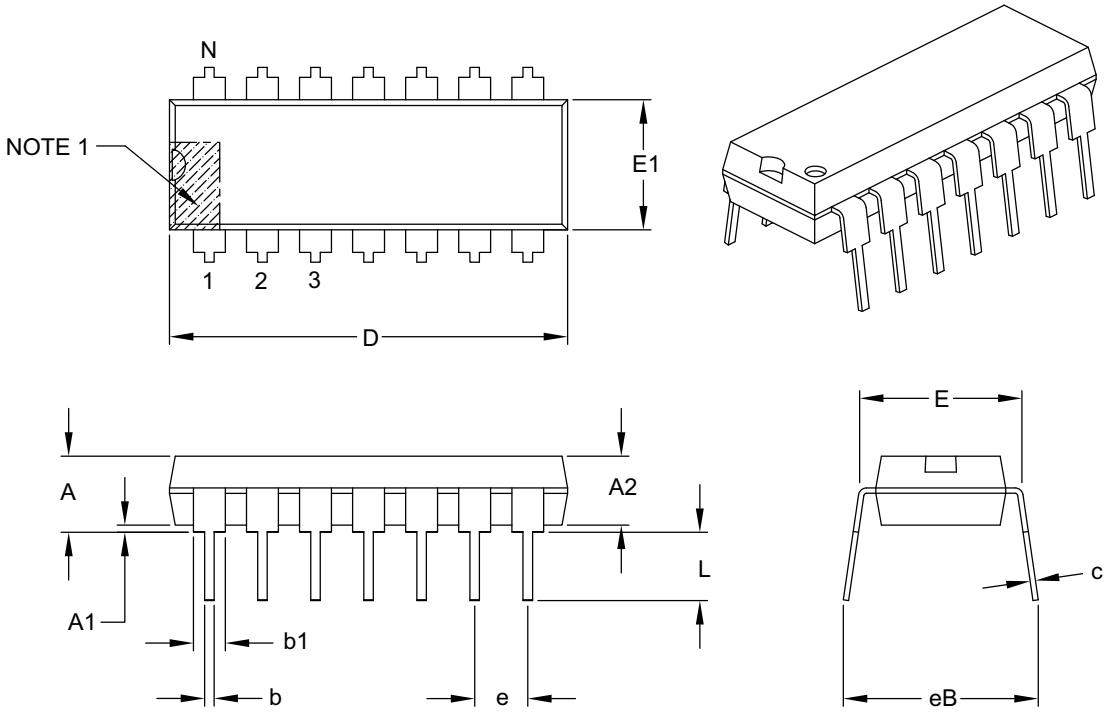
2: Only if Parameters 71A and 72A are used.

27.2 Package Details

The following sections give the technical details of the packages.

14-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		14	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.735	.750	.775
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.045	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

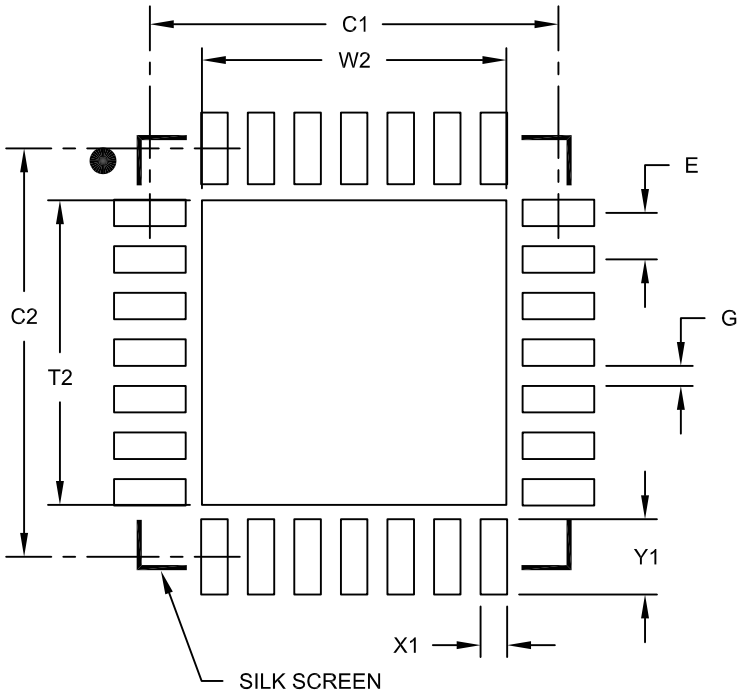
1. Pin 1 visual index feature may vary, but must be located with the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-005B

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

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